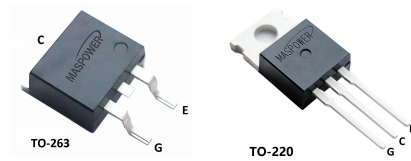


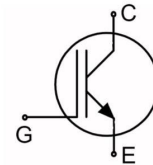
Features

- Low gate charge
 - Trench-Stop Technology
 - High speed switching
- Saturation voltage: $V_{CE(sat)}$, typ= 1.25V



Applications

- General purpose inverters
- Induction heating(IH)
- Welding Converters
- UPS



Absolute Ratings (T_c=25°C)

Parameter	Symbol	MSG50D60HLE0	Unit
Collector-Emitter Voltage	V _{ces}	600	V
Collector Current-continuous	I _c T _c =25°C T _c =100°C	100	A
		50	
Collector Current-pulse(note 1)	I _{CM}	300	A
Continuous Gate-Emitter Voltage	V _{GE}	±20	V
Transient Gate-emitter voltage	V _{GE}	±30	V
Power Dissipation	P _D T _c =25°C	260	W
Operating Temperature Range	T _J	-55~+150	°C
Storage Temperature Range	T _{STG}	-55~150	°C
Maximum Lead Temperature for Soldering Purposes	T _L	300	°C

Thermal Characteristic

Parameter	Symbol	Tests conditions	Min	Typ	Max	Units
Off-Characteristics						
Collector-Emitter Voltage	BV _{CES}	I _C =250μA, V _{GE} =0V	600	-	-	V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} =V _{CES} , V _{GE} =0V, T _J =125°C			25 250	μA
Gate-body leakage current	I _{GES}	V _{CE} =0V, V _{GE} =±20V	-	-	±100	nA
Transconductance	g _{fs}	V _{CE} =10V, I _C =40A	30	48	-	S

On-Characteristics						
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}, I_c=250\mu A$	3.0	-	6.0	V
Collector-Emitter saturation Voltage	V_{CESAT}	$V_{GE}=15V, I_c=50A$		1.25		V
Dynamic Characteristics						
Input capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V, f=1.0MHz$	-	3050	-	pF
Output capacitance	C_{oes}		-	168	-	pF
Reverse transfer capacitance	C_{res}		-	45	-	pF
Switching Characteristics						
Turn-On delay time	$t_{d(on)}$	$V_{CE}=480V, I_c=40A, R_G=5\Omega, V_{GE}=15.0V$ $T_J=25^{\circ}C$ Inductive Load	-	23	-	ns
Turn-On rise time	t_r		-	31	-	ns
Turn-off delay time	$t_{d(off)}$		-	326	-	ns
Turn-off Fall time	t_f		-	206	-	ns
Turn-on energy	E_{on}		-	0.91	-	mJ
Turn-off energy	E_{off}		-	2.73	-	mJ
Total Gate Charge	Q_g	$V_{CE}=300, I_c=40A, V_{GE}=15V$	-	100	-	nC
Gate to emitter charge	Q_{ge}			18		nC
Gate to collector charge	Q_{gc}			43		nC

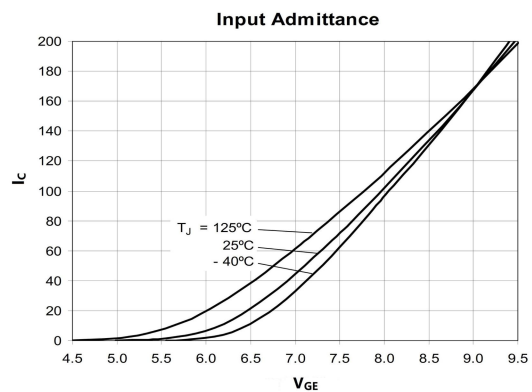
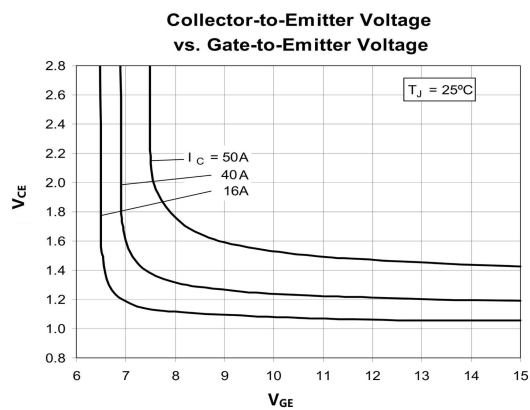
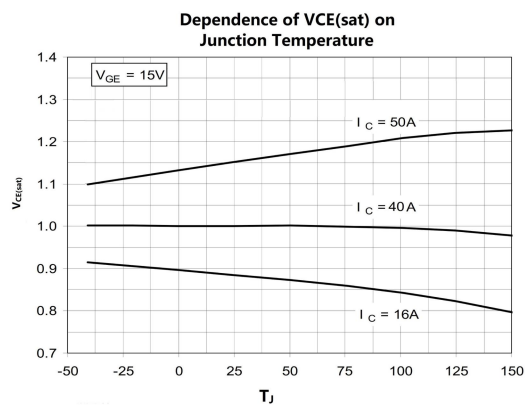
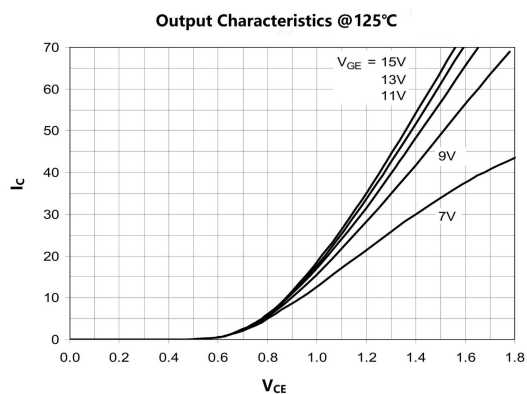
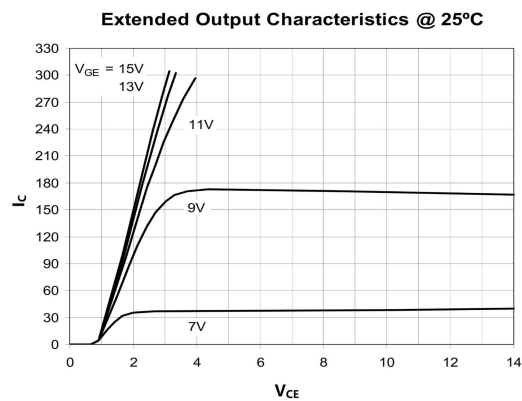
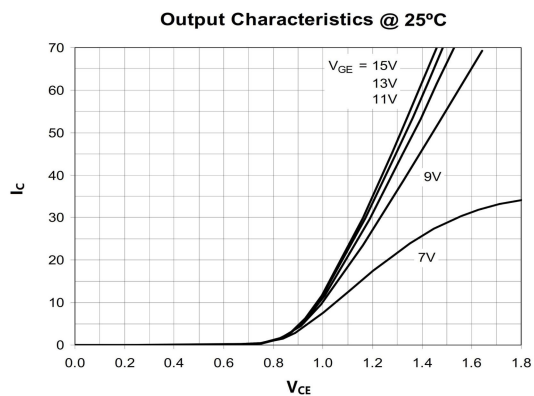
Thermal Characteristic

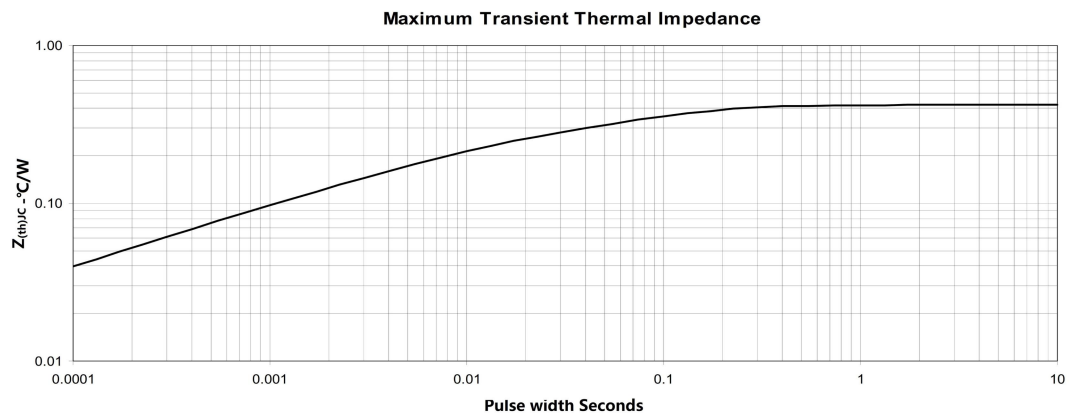
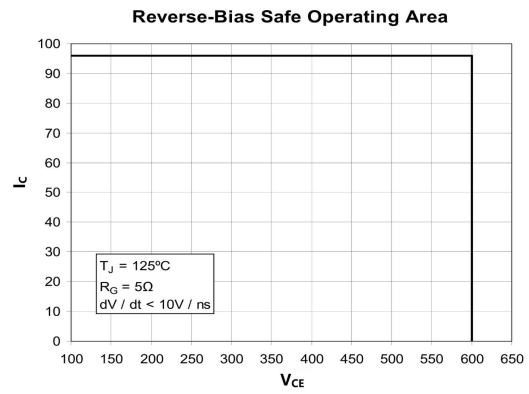
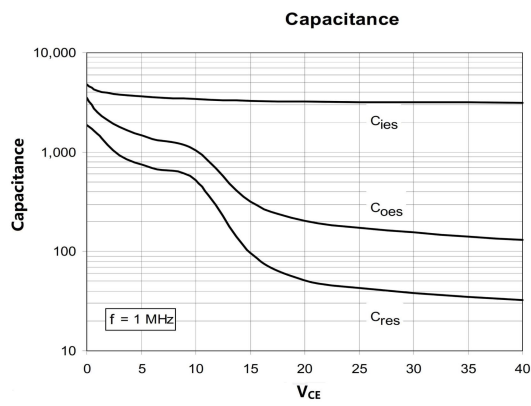
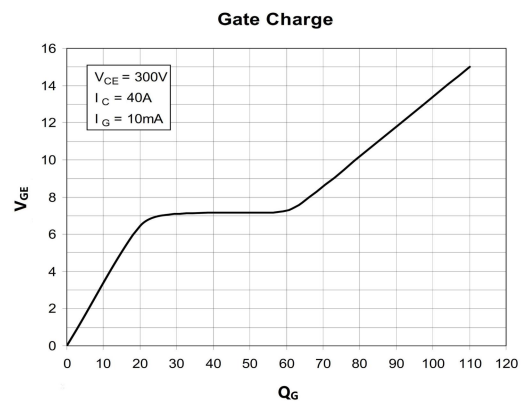
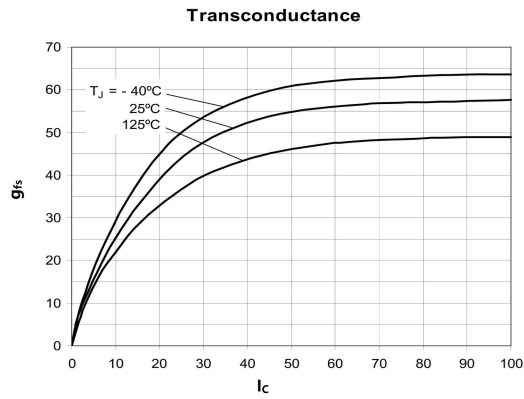
Parameter	Symbol	Max	Unit
IGBT Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.48	$^\circ C/W$
Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	40	$^\circ C/W$

Order Information

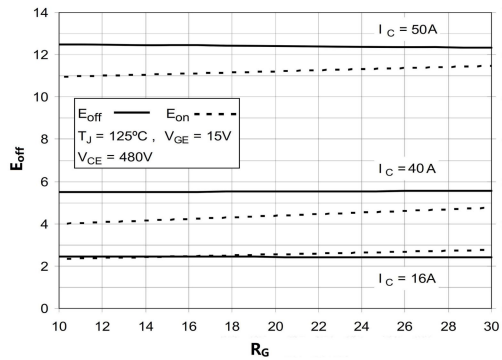
Order codes	Package	Packaging
MSG50D60HLE0	TO-263	Tube
MSG50D60HLT1	TO-220	Tube

Electrical Characteristics(curves)

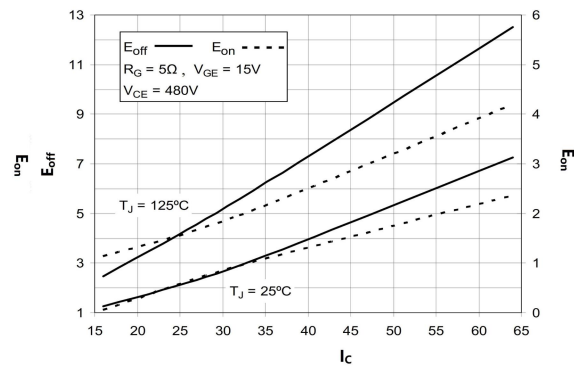




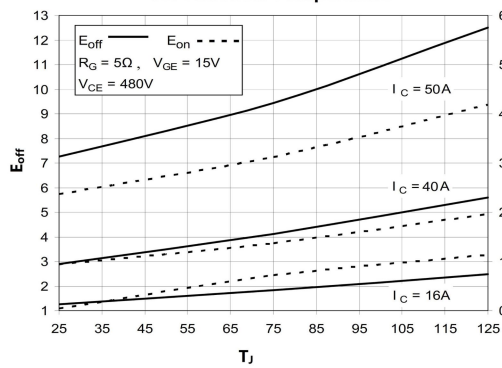
**Inductive Switching Energy Loss
vs. Gate Resistance**



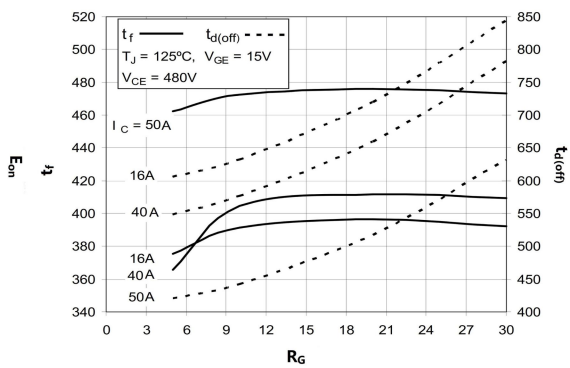
**Inductive Switching Energy Loss vs.
Collector Current**



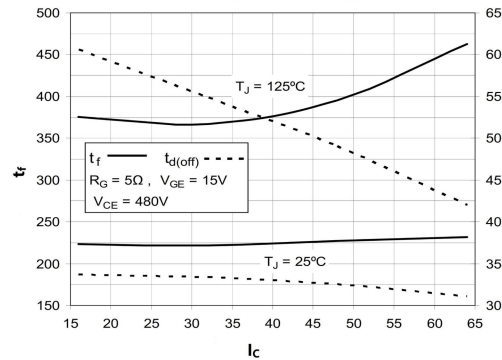
**Inductive Switching Energy Loss
vs. Junction Temperature**



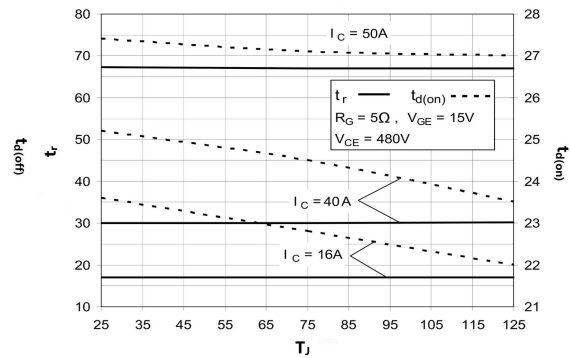
**Inductive Turn-off Switching Times
vs. Gate Resistance**



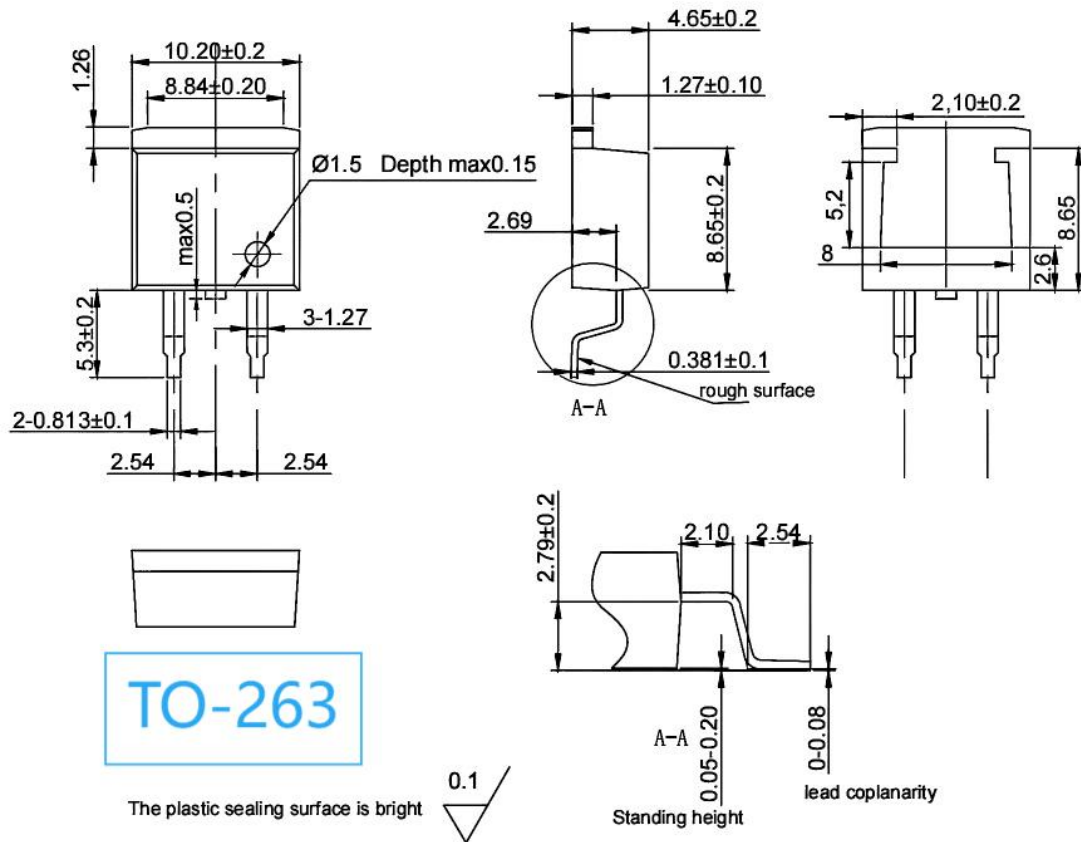
**Inductive Turn-off Switching Times
vs. Collector Current**



**Inductive Turn-on Switching Times
vs. Junction Temperature**

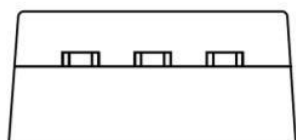
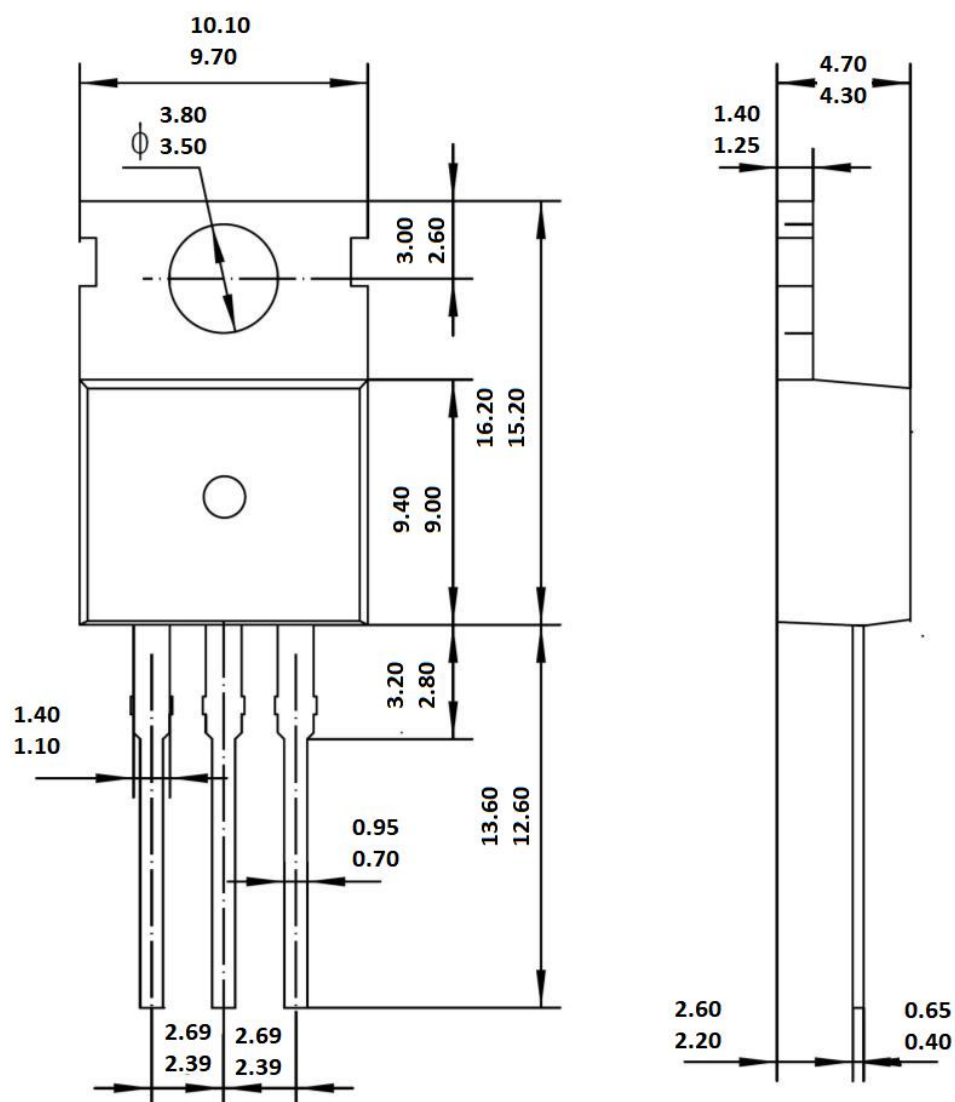


Package Mechanical DATA



Notes:

1. unmarked tolerance $\pm 0.15\text{mm}$; unmarked $R < 0.15\text{mm}$
2. The resin body is not allowed to have defects, shrinkage holes, cracks, bubbles and other harmful defects
3. The drawing indicates that the leg has reinforcement
4. The top pinhole is not allowed to protrude the surface of the plastic sealing body
5. Unit: mm



TO-220

Unit: mm